



32-BIT MCU FAMILY RENESAS RA4W1 GROUP

48MHz Bluetooth[®] 5.0 Low Energy Single Chip MCU from RA4 Series

The Renesas RA4W1 is the first Bluetooth 5.0 Low Energy fully compliant with 2Mbit High-Throughput (HT) and Long Range (LR) support in a single chip MCU of Renesas RA4 product series for IoT applications that require a high-performance Arm® Cortex®-M4 core at a very attractive price point. The RA4W1 is built on a highly efficient low power process and is supported by an open and flexible ecosystem concept, called Flexible Software Package (FSP), using FreeRTOS as base. RA4W1 is geared towards IoT application requiring Security, large embedded RAM and low power consumption.

Target Applications

- Security (Fire Detection, Burglar Detection, Panel control)
- Metering (Electricity, Automated Meter Reading)
- Industry (Robotics, Door Openers, Sewing Machines, Vending machines, UPS)
- Health and Wearables Body Sensors
- Smart Home and Remote Control Toys

Key Features

- 48MHz Arm[®] Cortex[®]-M4
- 512kB Flash Memory and 96kB SRAM
- 8kB DataFlash to store data as in EEPROM
- 7x7mm QFN 56 pin package.
- Capacitive Touch Sensing Unit
- Segment LCD Controller
- USBFS 2.0 Full Speed (Host/Device)

CAN 2.0B

RA4W1

RA4M1

Renesas

RA4

Series

SCI (UART, Simple SPI, Simple I2C)

48MHz, Arm[®] Cortex[®]-M4 512kB Flash, 96kB RAM

LCD Controller and Touch

48MHz, Arm[®] Cortex[®]-M4

LCD Controller and Touch

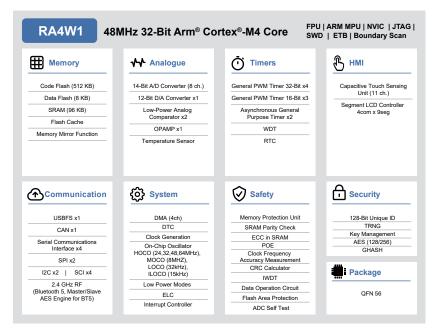
40-100pin, USB, CAN, Security

256kB Flash, 32kB RAM

QFN56, Bluetooth 5.0 USB, CAN, Security

- SPI/ I2C Multimaster Interface
- 2.4 GHz radio with Bluetooth 5.0 Low Energy
- Advertising Extension and Long Range support
- Secure Crypto Engine (AES128 / 256, GHASH, TRNG)

Block Diagram



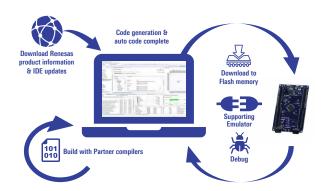
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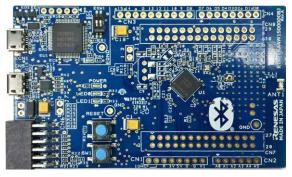


- Full functionality of Bluetooth 5.0 Low Energy along with the high-performance processing and superior power efficiency.
 High Throughput and Long Range support
- Integrated Secure Crypto Engine with several cryptography accelerators and Key management.
- Large 96kB embedded SRAM suitable for handling communication stacks.

Tools and Support

IDE	Renesas e ² studio	Keil MDK	IAR EWARM				
Compiler	GCCArm Compiler	 Arm Compiler 	IAR Arm Compiler				
Debugger	Renesas E2/E2 LiteSEGGER J-Link	SEGGER J-Link	IAR I-JetSEGGER J-Link				
Programmer	 Renesas PG-FP6 SEGGER J-Flash Third party solutions 						





Evaluation Kit: RTK7EKA4W1S00000BJ

Ordering References

Evaluation Kit

Full MCU evaluation including On-Chip debugger

Part name: RTK7EKA4W1S00000BJ

Part name	Flash	RAM	DataFlash	Operating Temperature	Package	Package dimensions	Pin Pitch
R7FA4W1AD2CNG	512kB	96kB	8kB	-40 to +85°C	QFN 56pin	7x7mm	0.5mm

For more details, please visit www.renesas.com/RA

renesas.com

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